

This listing replaces all prior listing of the claims.

IN THE CLAIMS:

Amend the claims as follows:

1. (Currently amended) A device for structuring a functional polymer, comprising at least one continuously moving web carrying a coated substrate, the coating forming a layer on the substrate, at least one laser for generating a beam, the laser, mask and substrate being disposed such that said coated substrate is bombarded by said laser beam through said mask such that the layer on said substrate is removed locally therefrom in conformity with the configuration of said mask.
2. (Currently amended) A device as defined in claim 1, wherein said laser emits the beam in the ultraviolet spectral region.
3. (Original) A device as defined in any one of the previous claims, wherein said laser is an excimer laser.
4. (Currently amended) A device as defined in any one of ~~the previous claims~~ claims 1 and 2, including a suction device for removing debris from said substrate.
5. (Currently amended) A process for structuring functional polymers by ~~means of~~ at least one laser ablation step, wherein, in a continuous working process, the image of a mask is projected by at least one laser pulse onto a continuous substrate coated with at least one functional polymer such that said functional polymer is locally removed in conformity with the configuration of said mask.

6. (Original) A process as defined in claim 5, wherein said continuous working process is a roller-to-roller process.

7. (Original) a process as defined in claim 5 or claim 6, wherein said laser ablation is effected by a single laser pulse.

8. (Currently amended) A process as defined in any one of claims 5 or 6 ~~the previous claims 5 to 7~~, wherein the projected image of said mask is reduced by a factor of 5.

9. (Currently amended) A method of using a device as defined in any one of claims 1 or ~~to 4~~ 2 and/or of using a process as defined in any one of claims 5 or ~~to 8~~ 6 for laser structuring electrodes, for structuring semiconductor and/or insulator layers, for making through-connections (via holes) of organic transistors and/or for the production of conducting paths, contact pads, resistors, electrodes, semi-conducting layers, insulator layers for electronic and/or electrical components, for condensers, organic diode structures, or organic photovoltaic structures.